

-12V/-2.6A P-Channel MOSFET**Features**

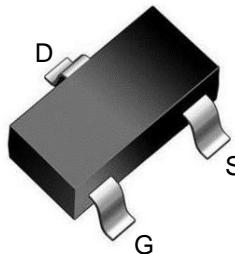
- Trench Power LV MOSFET technology
- High Density Cell Design for Low $R_{DS(ON)}$
- High Speed switching

Product Summary

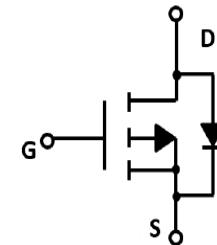
V_{DS}	$R_{DS(ON)} \text{ MAX}$	$I_D \text{ MAX}$
-12V	40mΩ@-4.5V	-2.6A
	50mΩ@-2.5V	

Application

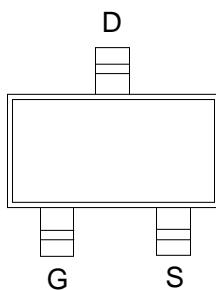
- Battery protection
- Load switch
- Power management



SOT-23 top view



Schematic diagram



Marking and pin assignment

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
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Common Ratings (TC=25°C Unless Otherwise Noted)

V_{DS}	Drain-Source Breakdown Voltage	-12	V
V_{GS}	Gate-Source Voltage	±8	V
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
I_S	Diode Continuous Forward Current	Tc=25°C	-2.6

Mounted on Large Heat Sink

I_{DM}	Pulse Drain Current Tested	Tc=25°C	-10.0	A
I_D	Continuous Drain Current	Tc=25°C	-2.6	A
P_D	Maximum Power Dissipation	Tc=25°C	0.5	W
R_{QJA}	Thermal Resistance Junction-to-Ambient		250	°C/W

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, ID=-250μA	-12	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-10V, V _{GS} =0V	--	--	-1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±8V, V _{DS} =0V	--	--	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , ID=-250μA	-0.4	-0.7	-1.5	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =-4.5V, ID=-2.6A	--	30	40	mΩ
		V _{GS} =-2.5V, ID=-2.3A	--	39	50	mΩ
		V _{GS} =-1.8V, ID=-1.8A	--	54	80	mΩ

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated)

C _{ISS}	Input Capacitance	V _{DS} =-9V, V _{GS} =0V, f=1MHz	--	1015	--	pF
C _{OSS}	Output Capacitance		--	138	--	pF
C _{RSS}	Reverse Transfer Capacitance		--	105	--	pF

Switching Characteristics

Q _g	Total Gate Charge	V _{DS} =-9V, ID=-5.6A, V _{GS} =-4.5V	--	11.3	--	nC
Q _{gs}	Gate Source Charge		--	2.3	--	nC
Q _{gd}	Gate Drain Charge		--	2.4	--	nC
t _{d(on)}	Turn-on Delay Time	V _{DD} =-9V, ID=-1A, V _{GS} =-4.5V, RG=2.5Ω	--	8.5	--	nS
t _r	Turn-on Rise Time		--	35.5	--	nS
t _{d(off)}	Turn-Off Delay Time		--	78	--	nS
t _f	Turn-Off Fall Time		--	58	--	nS

Source- Drain Diode Characteristics

V _{SD}	Forward on voltage	T _J =25°C, I _S =-2.6A,	--	--	-1.2	V
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Typical Operating Characteristics

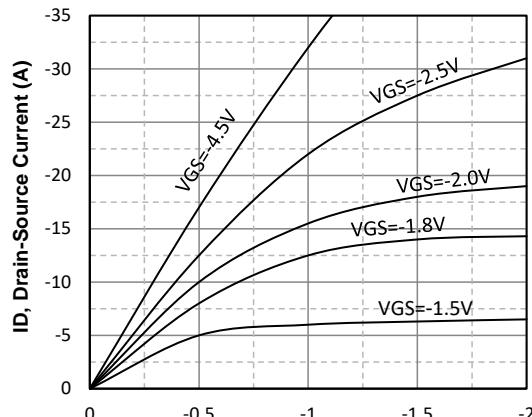


Fig1. Typical Output Characteristics

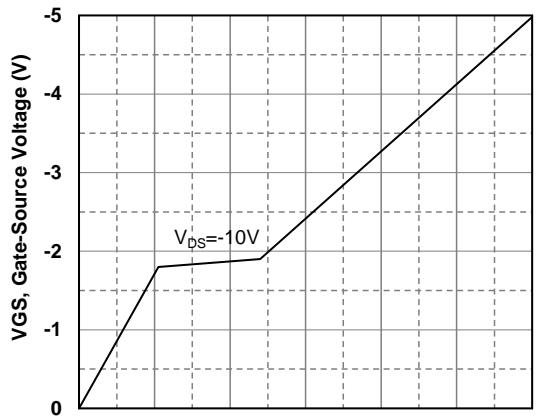


Fig2. Typical Gate Charge Vs.Gate-Source Voltage

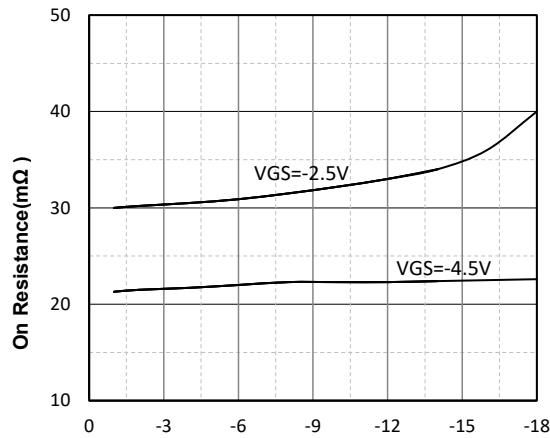


Fig3. Drain-Source on Resistance

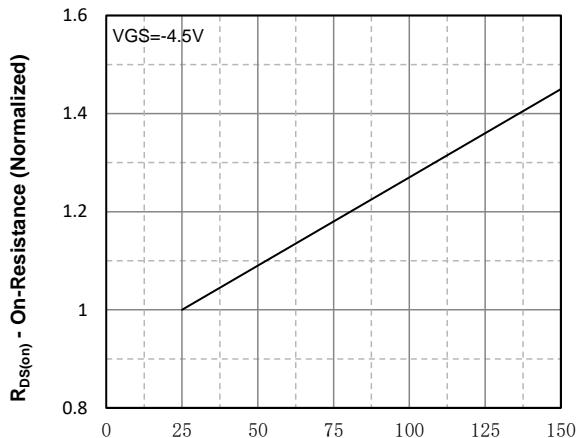


Fig4. Normalized On-Resistance Vs. Temperature

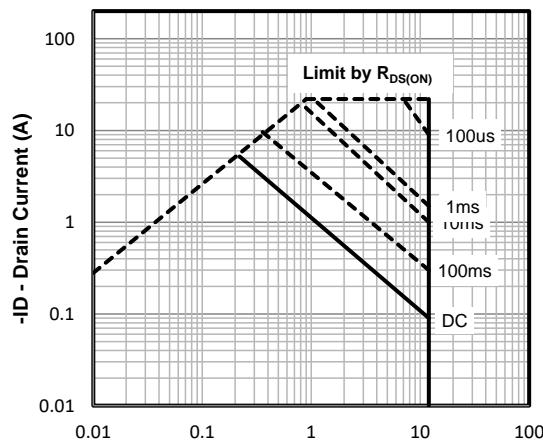


Fig5. Maximum Safe Operating Area

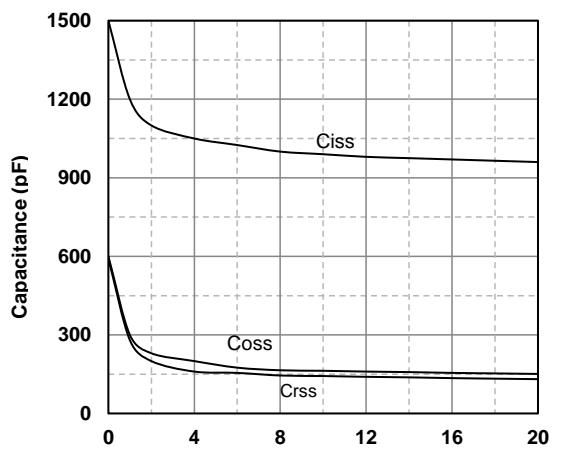
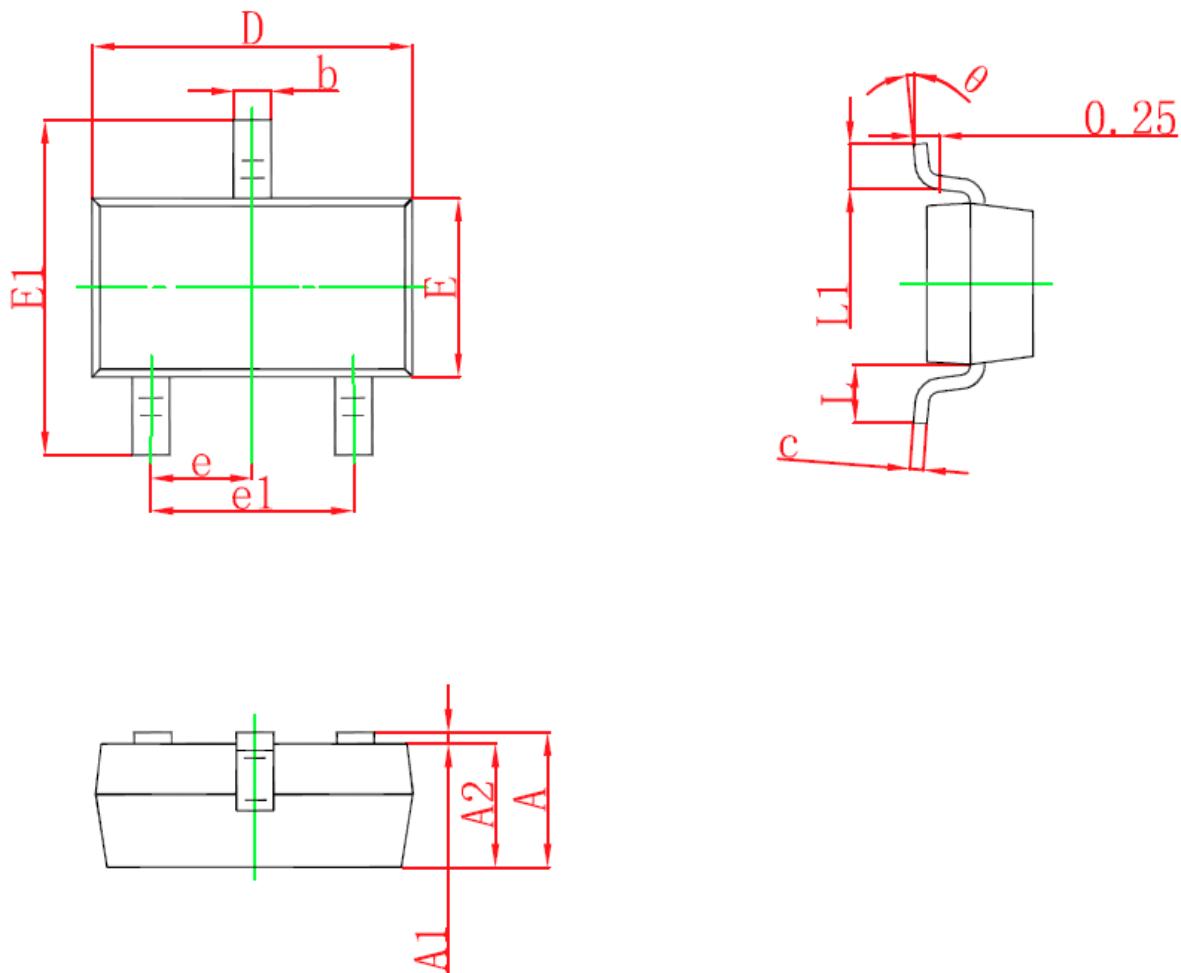


Fig6 Typical Capacitance Vs.Drain-Source Voltage

SOT-23 Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E1	2.250	2.550	0.088	0.100
E	1.200	1.400	0.047	0.055
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°